

The first results on cryogenic semiconductor detectors for advancing the LHC beam loss monitors

Presented by

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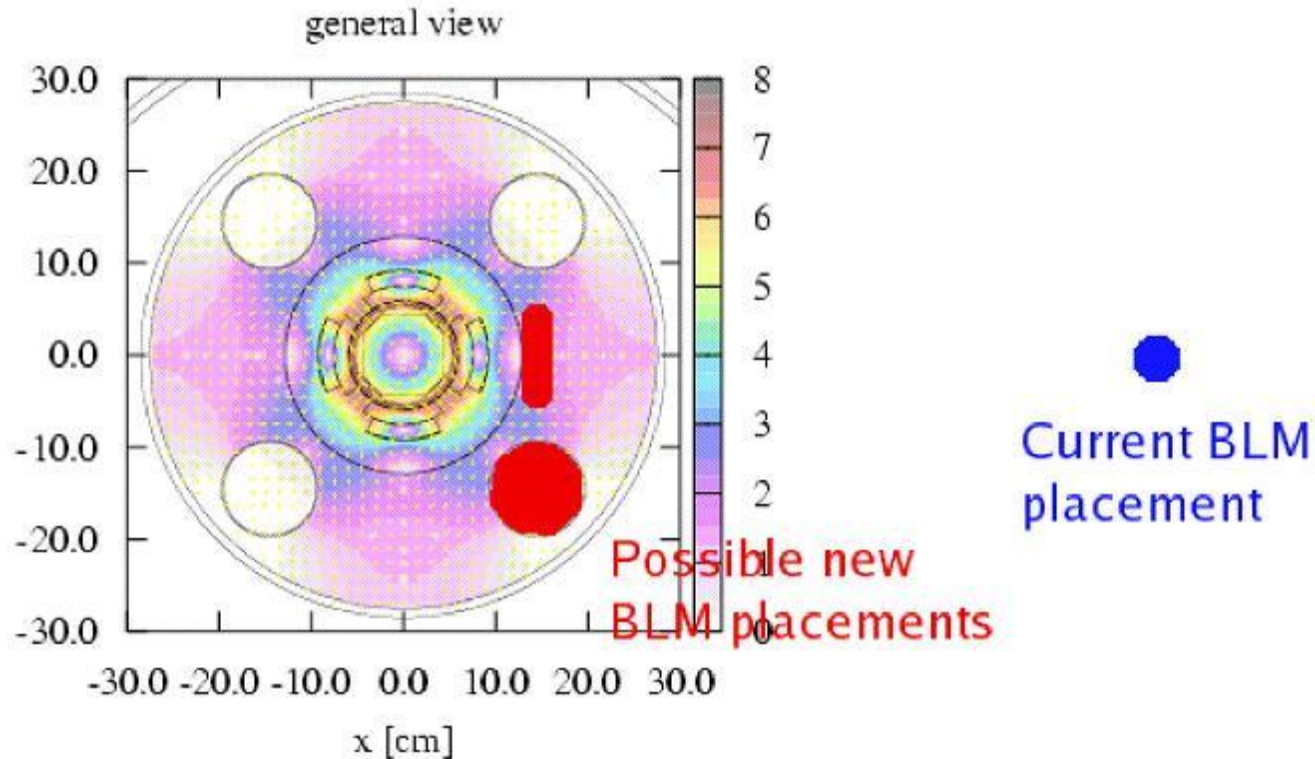
on behalf of

Ioffe PTI (St.Petersburg)

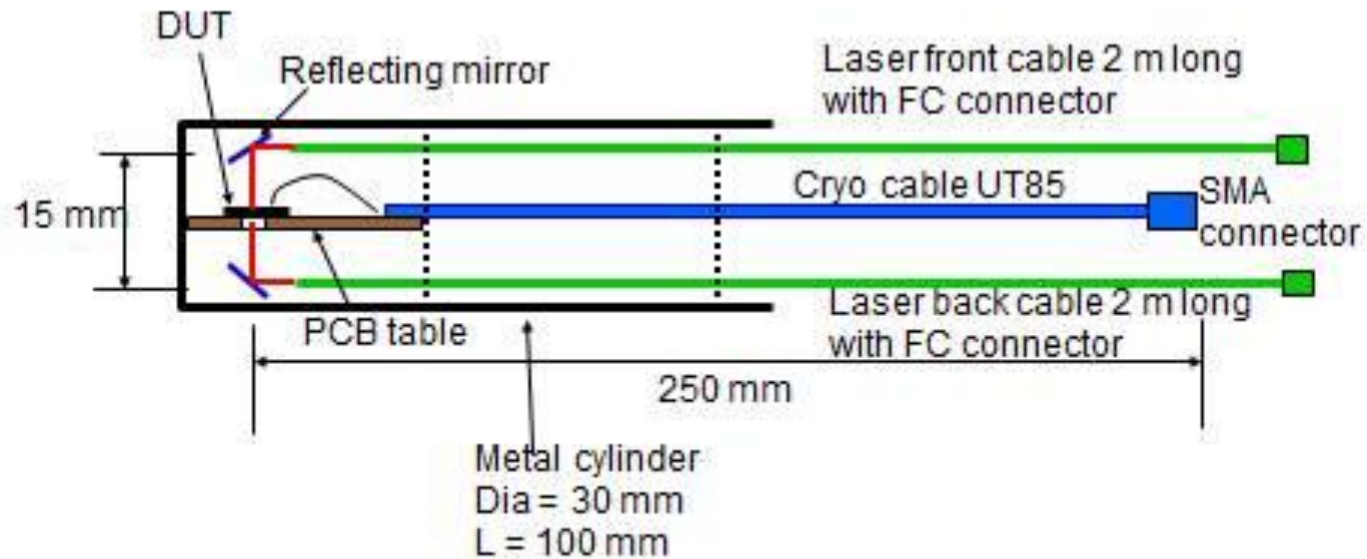
RIMST (Zelenograd)

BE-BI-BL, Cryo lab., and RD39 (CERN) teams

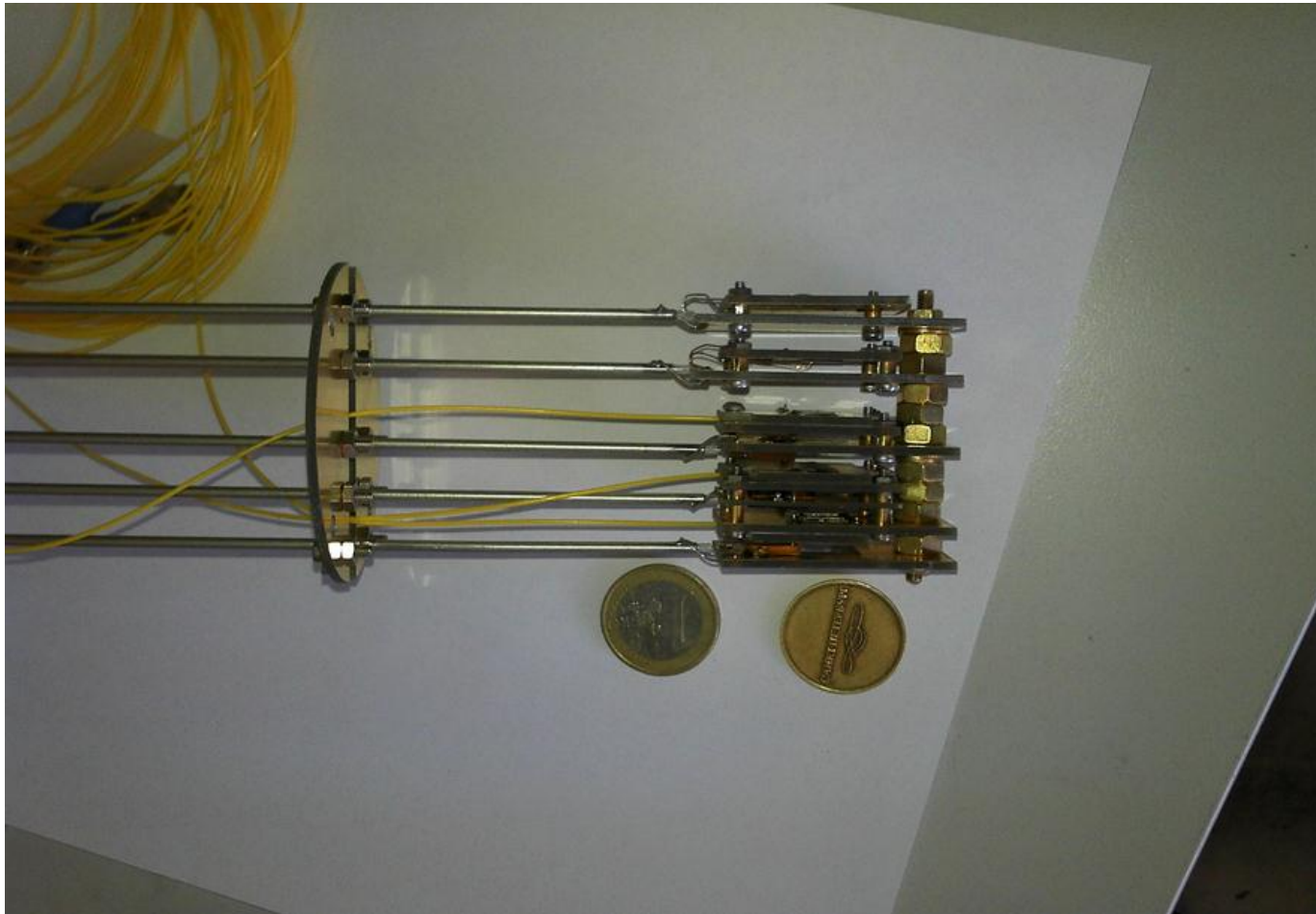
The new BLM arrangement



TCT cryogenic module



Arrangement with 5 cryogenic modules



Inside the cryostat

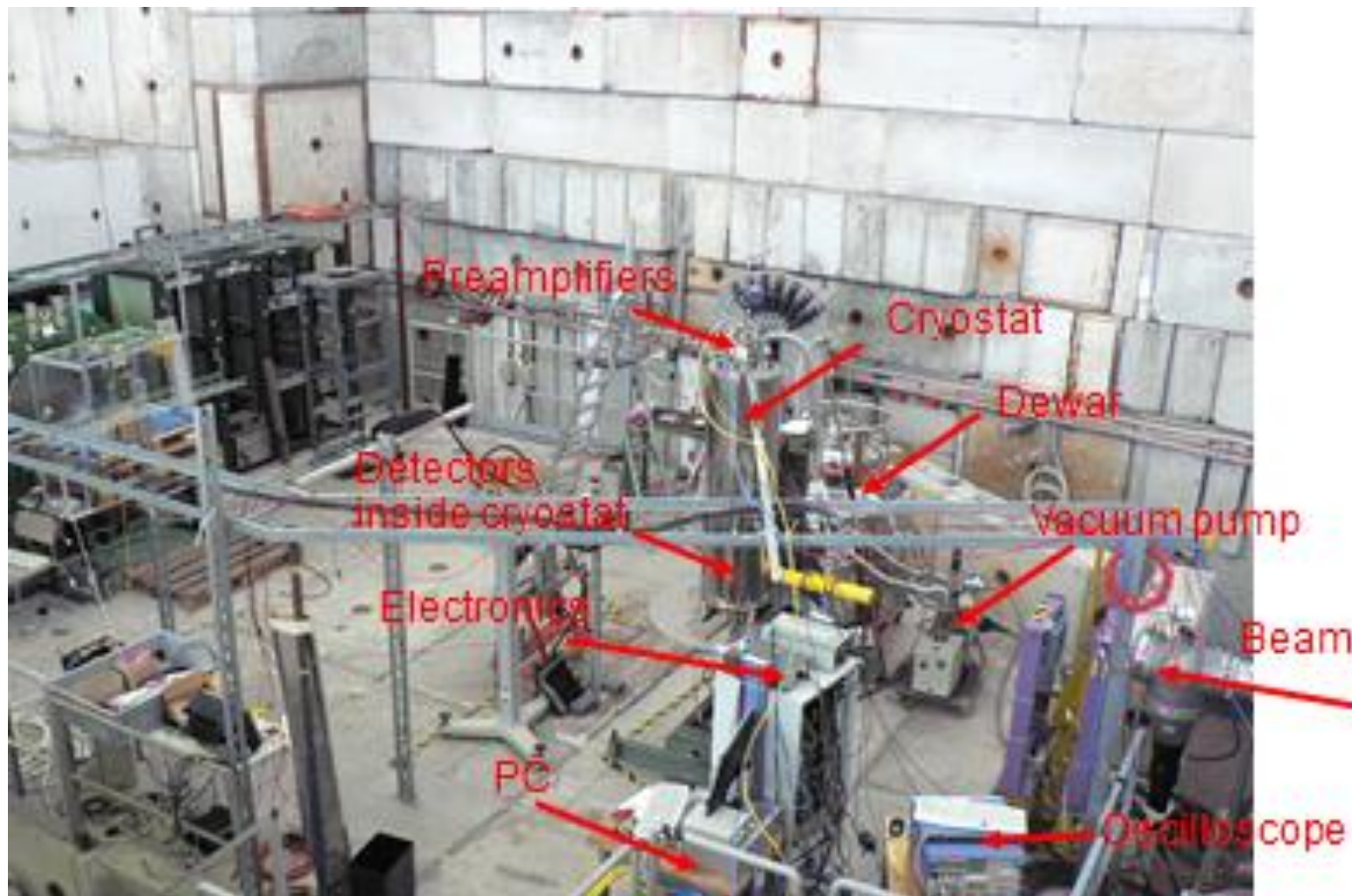


Cryostat

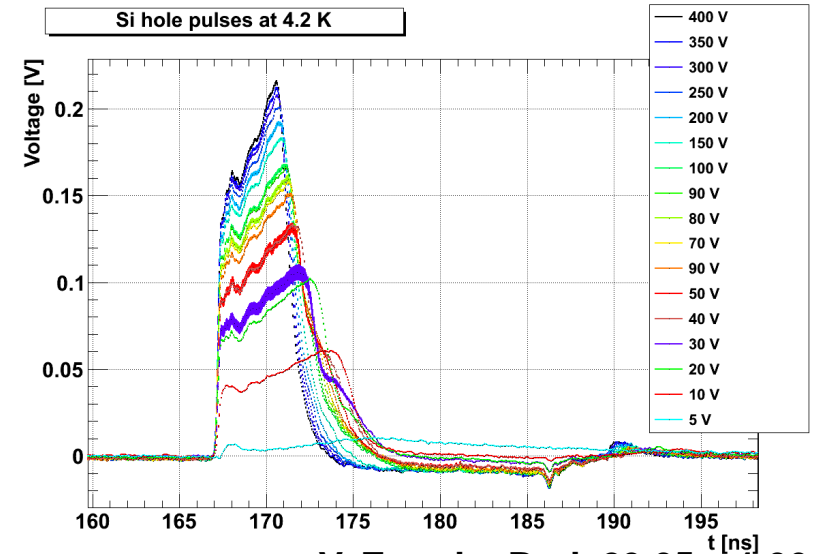
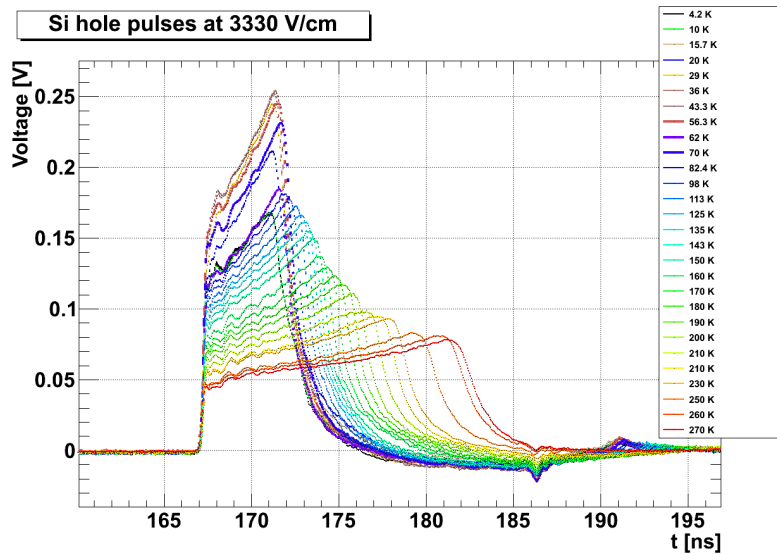
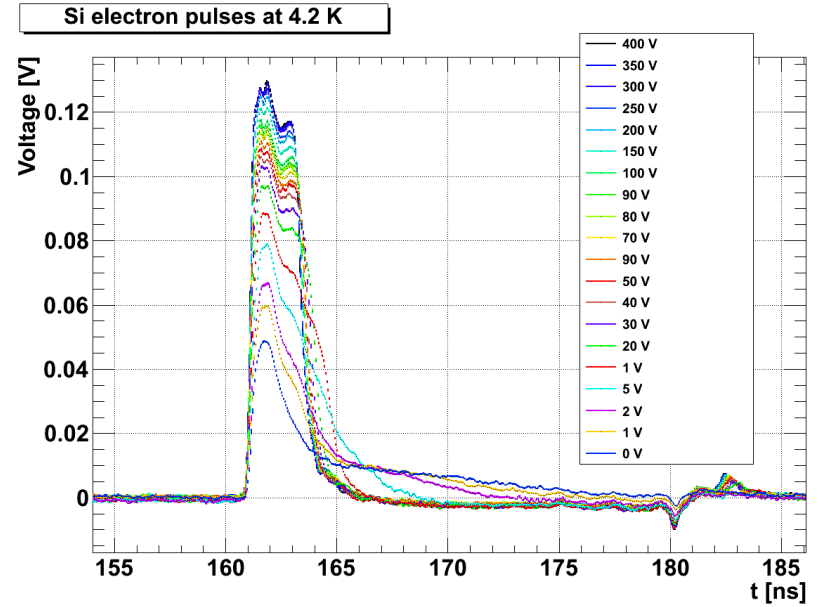
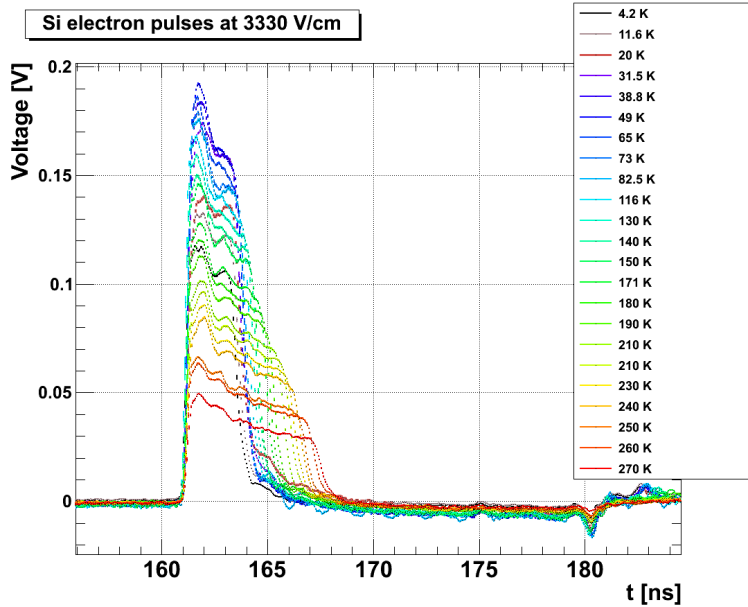


V. Eremin, Bari, 29.05 – 1.06.12

The beam test area

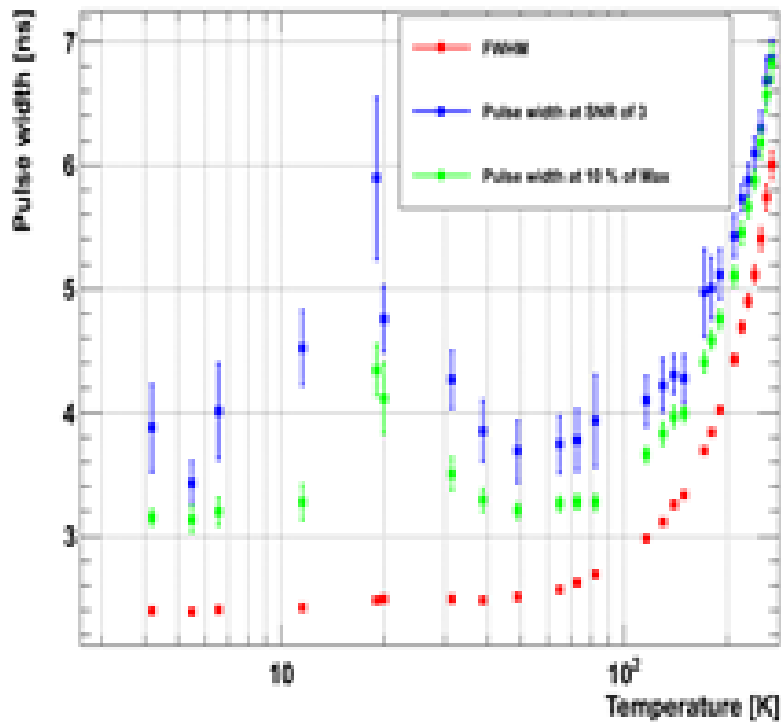


Charge collection

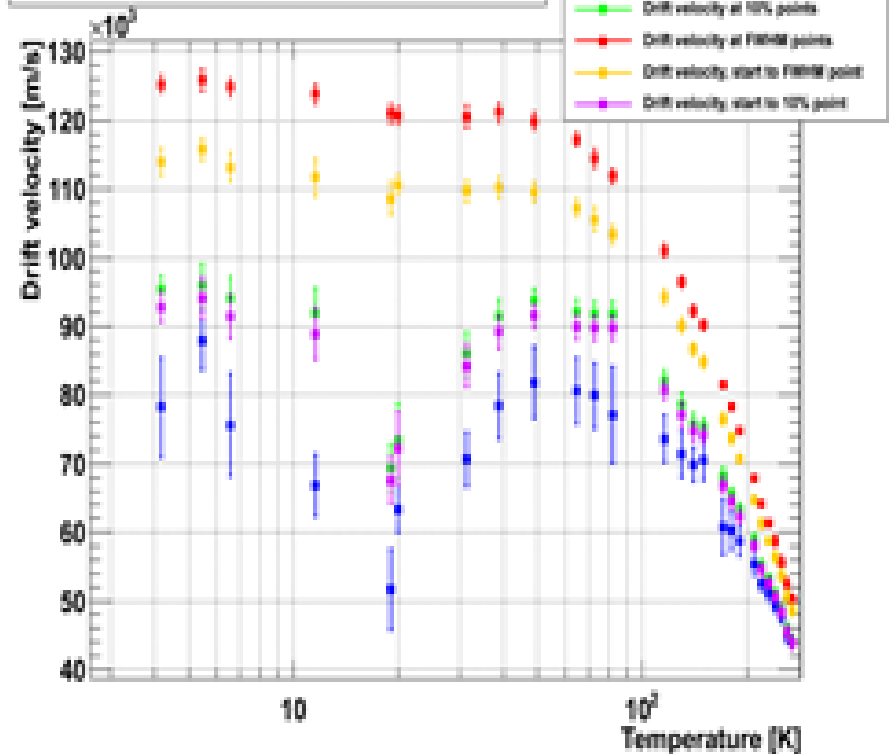


Electron collection

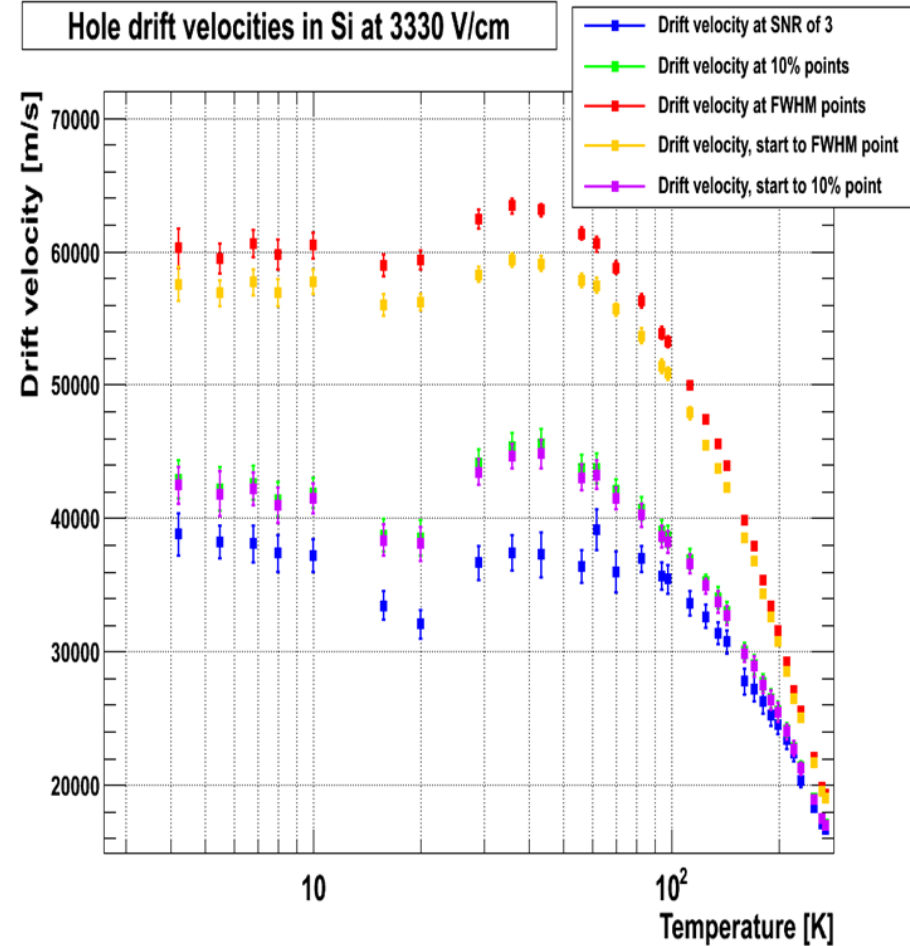
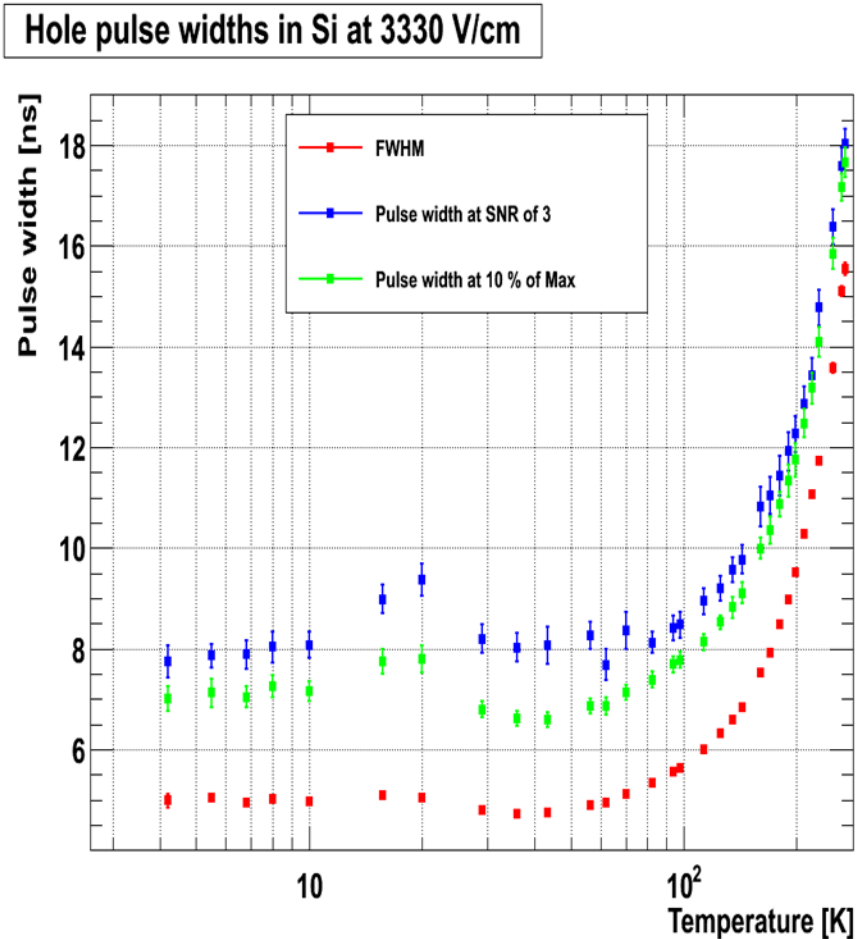
Electron pulse widths in Si at 3330 V/cm



Electron drift velocities in Si at 3330 V/cm

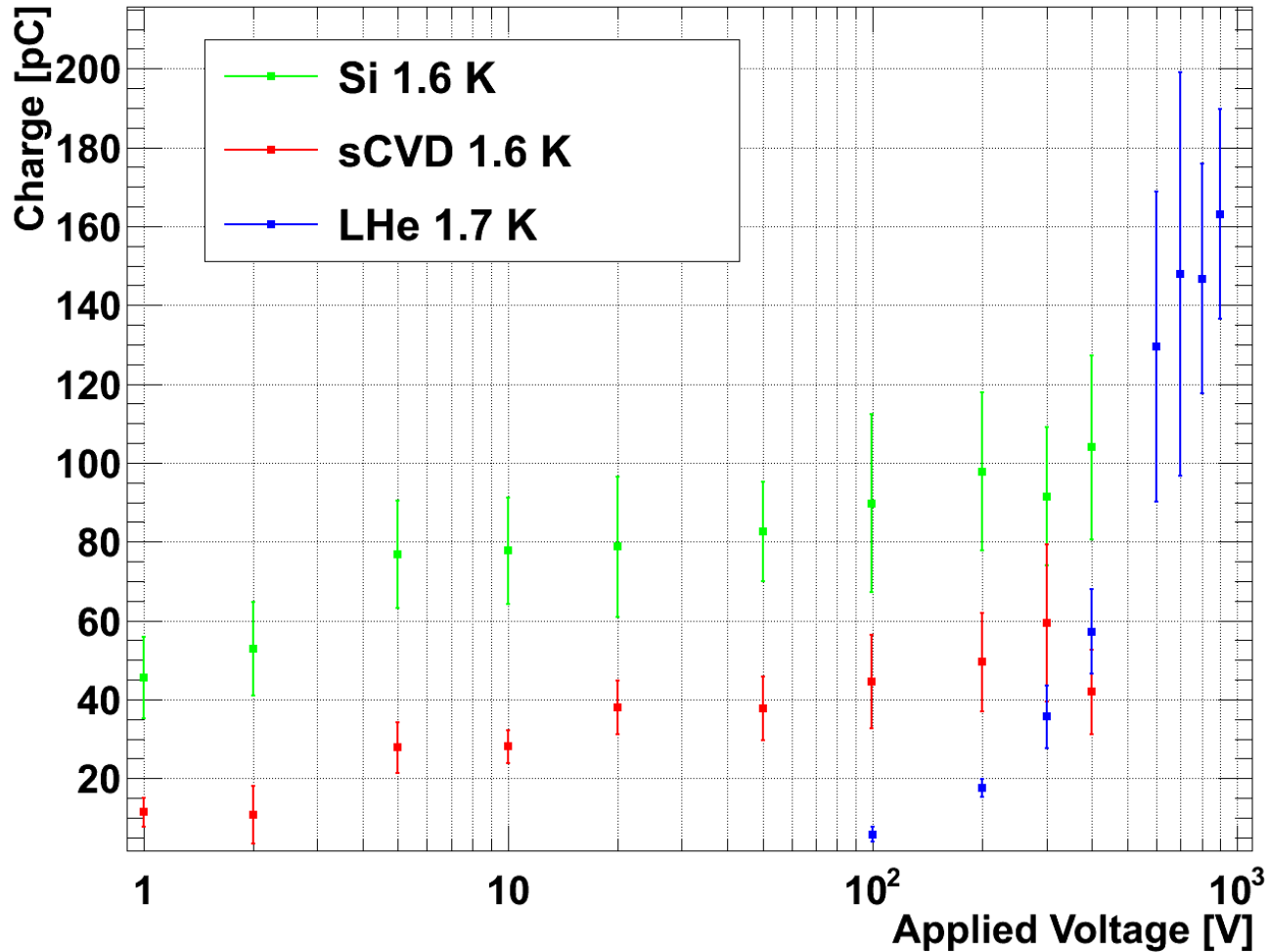


Hole drift velocity

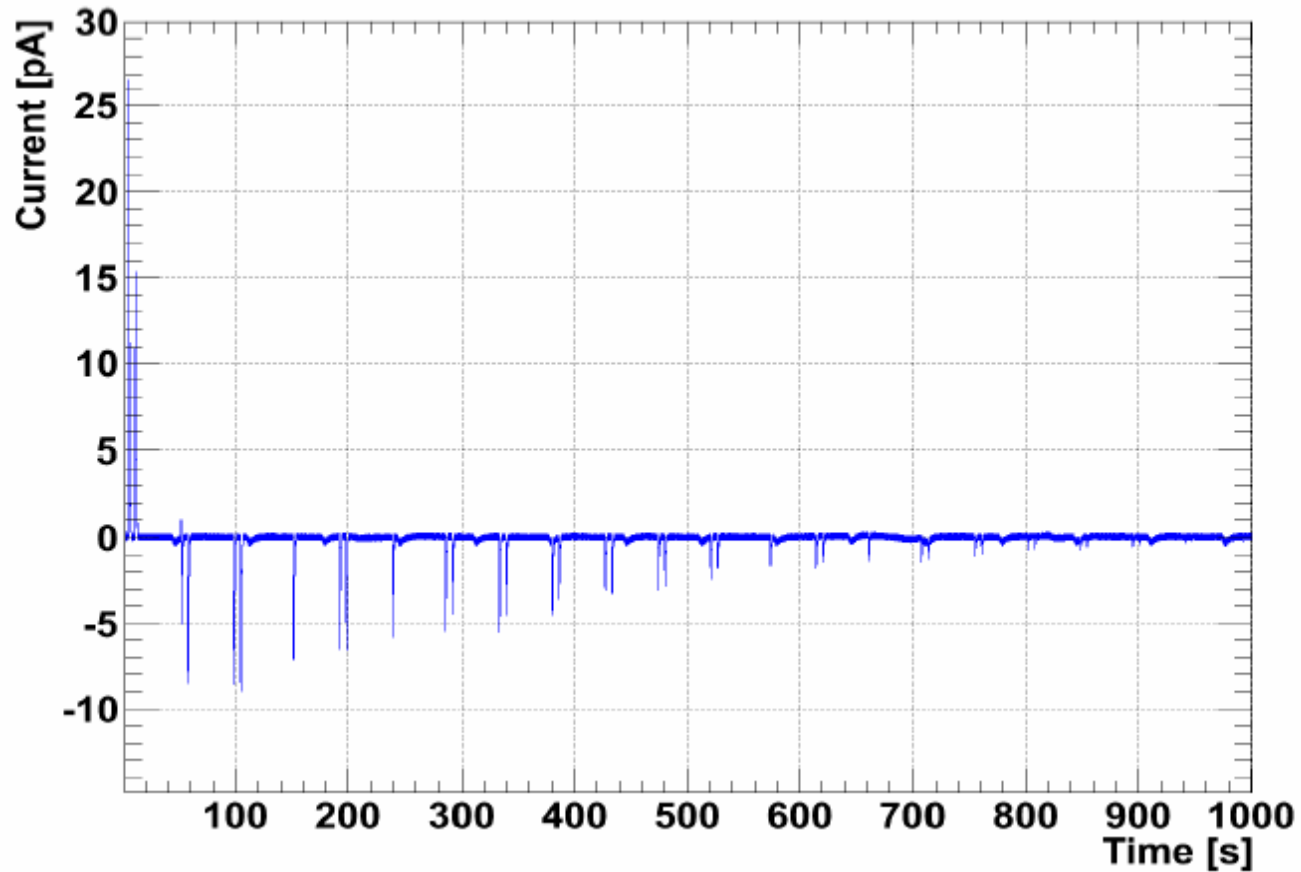


Collected charge in Silicon and Diamond detectors

Charge collection comparison between detectors

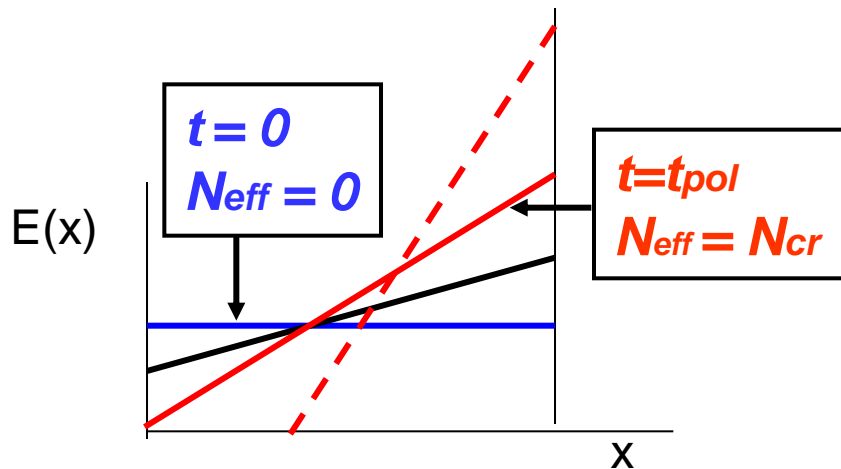


Sc diamond detector polarization



Polarization time in diamond

- The polarization criteria



Polarization by trapping:

MGA (2.7eV)

$\sigma_{tr} = 1e-15 \text{ cm}^2$, $N_{tr} = 1e15 \text{ cm}^{-3}$

RT

Trapping time = $1e-7 \text{ c}$

Detrapping time = $1e35 \text{ c}$

Collection time = $1e-8 \text{ s}$

Detector at:

$V_b = 1000 \text{ V}$

$W = 500 \mu\text{m}$

$N_{cr} = 1e12 \text{ cm}^{-3}$

$\bar{n}_{cr} = N_{cr} \times W = 1e11 \text{ cm}^{-2}$

Polarization time (estimation)

$R = 1e6 \text{ MIP cm}^{-2} \text{ c}^{-1}$

1MIP – $1e4$ pairs

CCE = 0.9

$\bar{n}_{tr} = 1e4 \times (1 - \text{CCE}) \times R = 1e9 \text{ cm}^{-2} \text{ c}^{-1}$

$t_{pol} = \bar{n}_{cr} / \bar{n}_{tr} = \mathbf{100 \text{ c}}$

More details on polarization:

B. Dezellie, et al. NIM A 452, 2000, p.440

Electric field evolution in detectors under bulk polarization

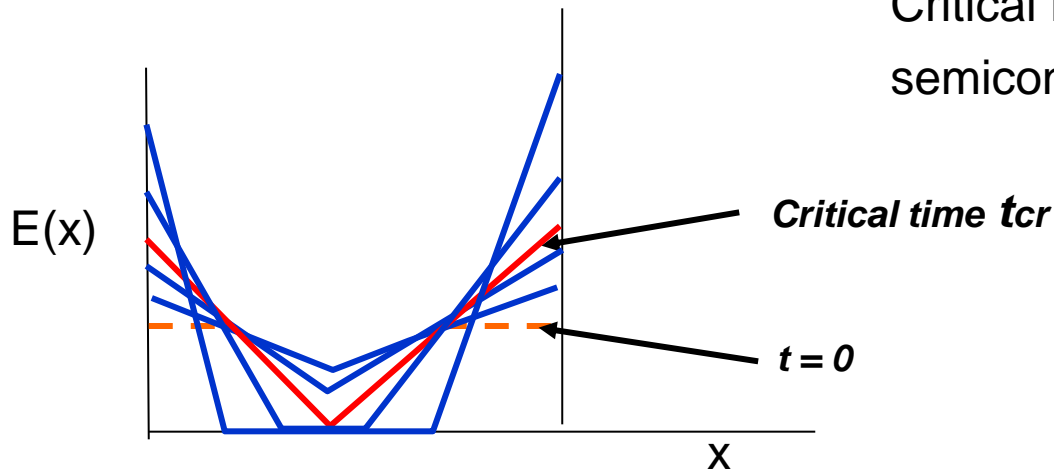


$$t_{pol} = C \cdot V / \{I \cdot (1 - CCE)\}$$

At $J_{bulk} = 1e-9 \text{ A/cm}^2$

$t_{pol} = < 1000c$!!!!

Critical for deep level rich semiconductors



Electric field evolution in detectors under charge accumulation at the contacts

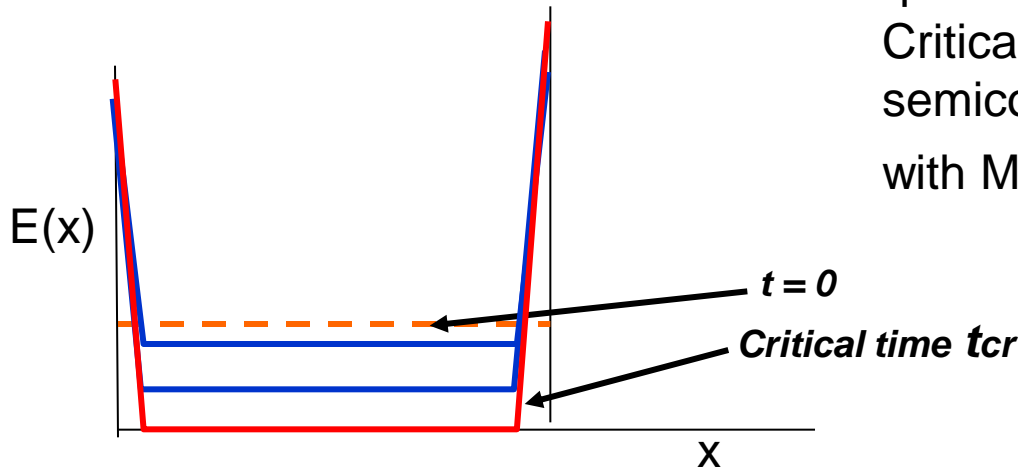


$$t_{pol} = C \cdot V / \{I \cdot (1 - CCE)\}$$

At $J_{bulk} = 1e-9 \text{ A/cm}^2$

$t_{pol} = < 1000c \text{ !!!!}$

Critical for the wide band semiconductor detectors with M-S-M structure

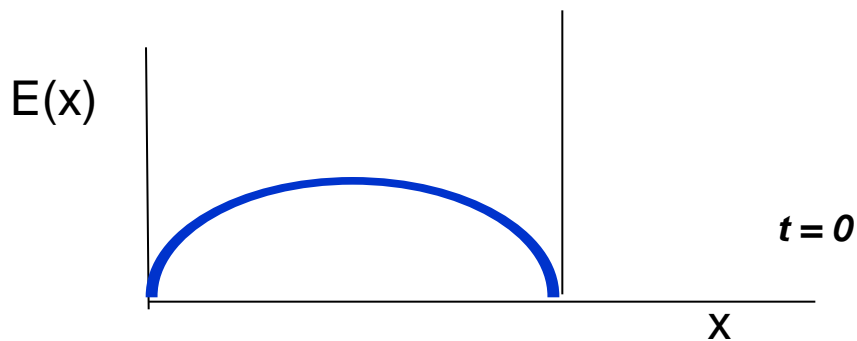


Double side injection structures as a possible solution

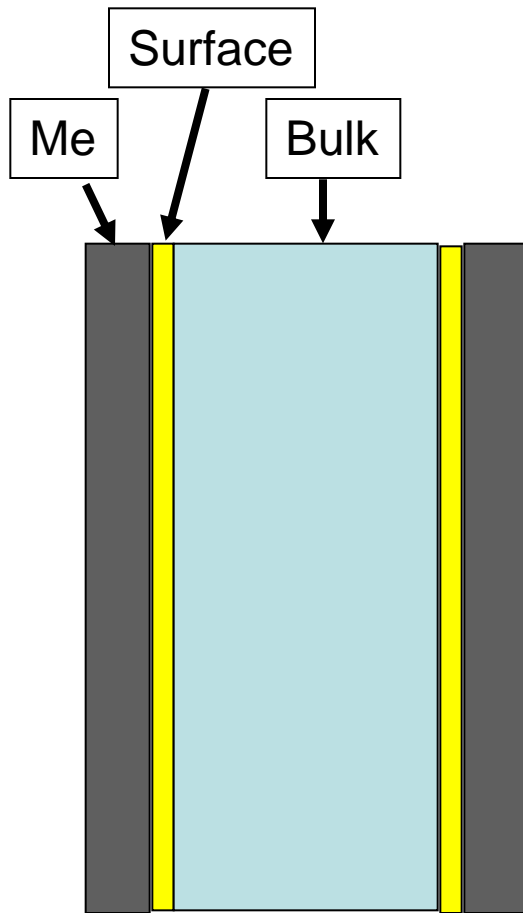


$$E(n+) = E(p+) = 0$$

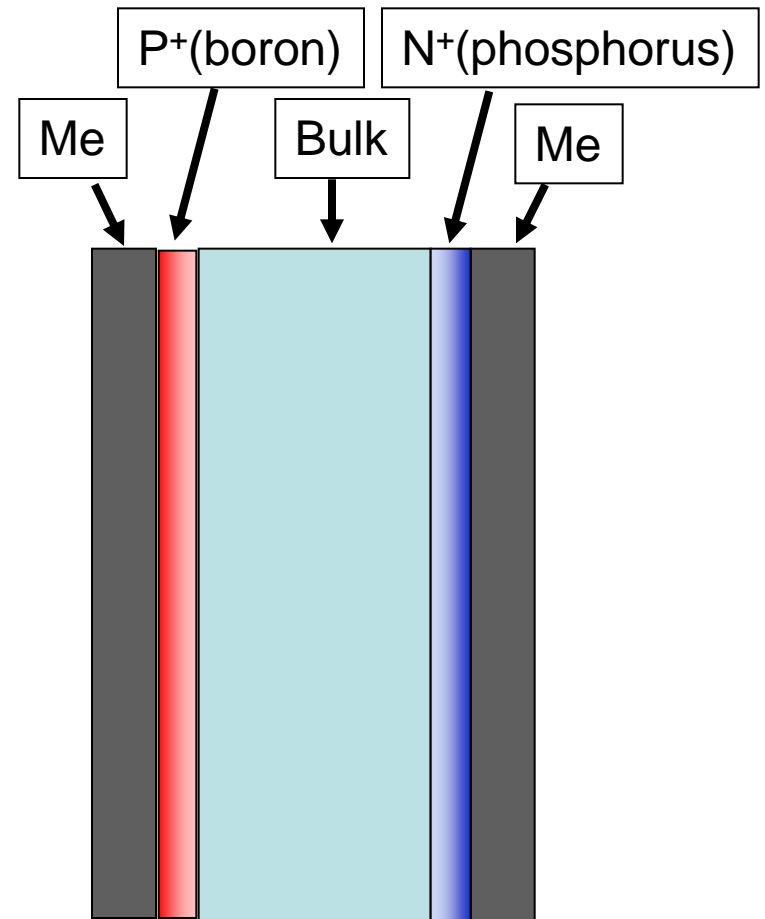
Critical condition:
Injection at cryogenic temperatures.
The best candidate – silicon P-I-N structure with **highly doped contacts.**



Comparison of Surface-barrier and P-I-N detectors

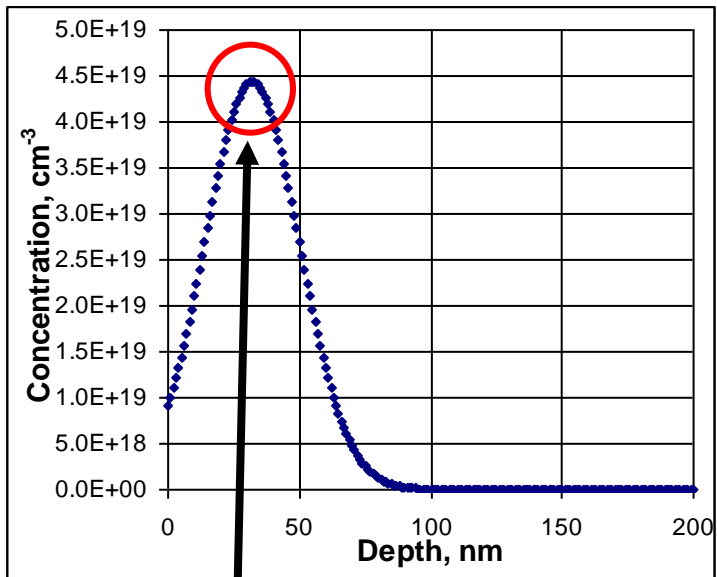


S/B detector
or M-S-M

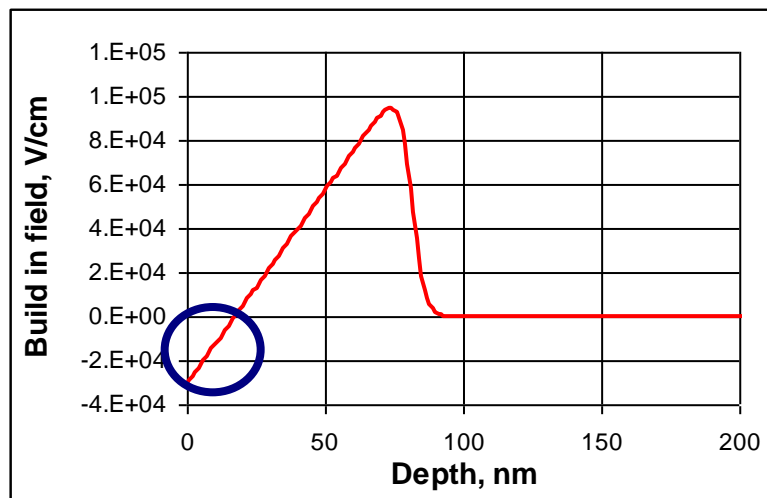
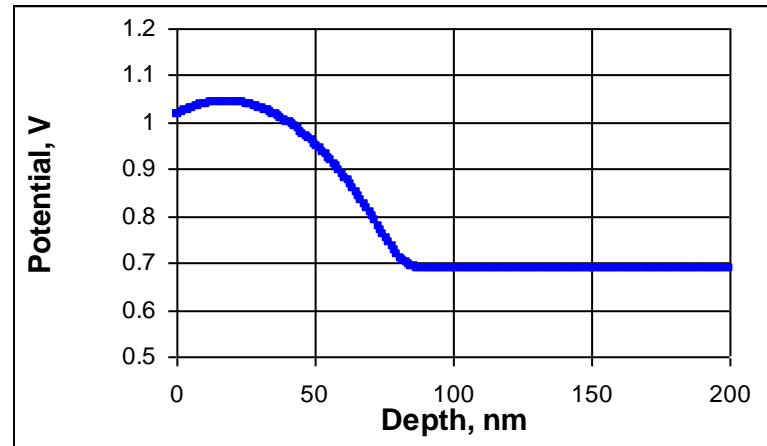


P-I-N

Electric field and potential at the detector entrance window



Degenerate Silicon
Si=Me



Conclusions

- **Polarization could be a major drawback for Diamond and Silicon detectors operated at high counting rate at very low temperatures.**
- **The possible solution for Silicon detectors is a P-I-N structures with thin and abrupt highly doped contacts.**
- **For Diamond detectors the solution is not evident.**
- **The modules with optimized P-I-N structures must be studied with MIP's laser simulator and in test beams of 2012.**

Thank you for your attention